

C1808C471JGGACTU

Aliases (C1808C471JGGAC7800) SMD Comm COG HV, Ceramic, 470 pF, 5%, 2,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1808, 2.9 mm



General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	62 mg
Shelf Life	78 Weeks
MSL	1

470 pF

100 GOhms

Dimensions	
Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
Т	1.4mm +/-0.15mm
S	2.9mm MIN
В	0.6mm +/-0.35mm

4.7mm +/-0.5mm	Measurement Condition	1 MHz 1.0Vrms
2mm +/-0.2mm	Tolerance	5%
1.4mm +/-0.15mm	Voltage DC	2000 VDC
2.9mm MIN	Dielectric Withstanding Voltage	2,400 VDC
0.6mm +/-0.35mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
T&R, 180mm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
1000	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour

Insulation Resistance

Specifications

Capacitance

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

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